

S-82D9 Series

Rev.1.1 00

www.ablic.com

BATTERY MONITORING IC

© ABLIC Inc., 2025

This IC is a battery monitoring IC developed using CMOS technology. Compared with conventional CMOS voltage detectors, this IC is ideal for the applications that require high-withstand voltage due to its maximum operation voltage as high as 24 V.

This IC is capable of confirming the voltage in stages since it detects four voltage values.

The S-82D9A Series has an EN pin, allowing for reduction of current consumption by using an external signal to turn off this IC.

The S-82D9B Series has a SENSE pin, and the SENSE pin and external components enable battery monitoring equal to or higher than the rated voltage of the IC.

Features

 Detection voltage accuracy: 	±1.0%
 Hysteresis characteristics: 	V _{HYS1(S)} to V _{HYS4(S)} = 0 mV, 50 mV, 300 mV, 400 mV, 500 mV
 Current consumption: 	During operation: $I_{DD1} = 10 \ \mu A \ max$.
	During power-off: I _{DD2} = 0.1 μA max.
 Operation voltage range: 	V _{DD} = 3.6 V to 24 V
 Detection voltage: 	V _{DET1(S)} to V _{DET4(S)} = 7.5 V to 21.5 V (0.1 V step)
Output form:	Nch open-drain output
 Output logic^{*1}: 	Full charge all on, Individual step voltage on
 SENSE pin power-off voltage: 	V _{SENSE} < 0.3 V (S-82D9B Series)
 Voltage detection pin: 	S-82D9A Series: VDD pin
	S-82D9B Series: SENSE pin
 Operation temperature range: 	Ta = -40°C to +85°C
 Lead-free (Sn 100%), halogen-free 	

 *1. Full charge all on: The multiple output pins become V_{SS} output depending on the input voltage. When the input voltage is equal to or higher than each of the four detection voltage values, V_{OUT1} = V_{OUT2} = V_{OUT3} = V_{OUT4} = V_{SS}.

Individual step voltage on: According to the input voltage, only one output pin is a V_{SS} output.

Set the detection voltage to VDET1 > VDET2 > VDET3 > VDET4 and

 $V_{DETn} > V_{DETn+1} + V_{HYSn+1}$.

 $V_{OUT1} = V_{SS}$ and $V_{OUT2} = V_{OUT3} = V_{OUT4} =$ High-Z when the input voltage is equal to or higher than detection voltage 1 (V_{DET1}).

Application

• Rechargeable lithium-ion battery pack

Package

• HTMSOP-8

Block Diagram

1. S-82D9A Series



Remark Diodes in the figure are parasitic diodes.

Figure 1

2. S-82D9B Series



Remark Diodes in the figure are parasitic diodes.

Figure 2

Product Name Structure

1. Product name



- ***1.** Refer to the tape drawing.
- *2. Refer to "3. Product name list".
- ***3.** EN pin function: The EN pin can control the state of the IC. SENSE pin function: The SENSE pin can monitor the battery voltage.

2. Package

Table 1 Package Drawing Codes

Package Name	Dimension	Таре	Reel	Land
HTMSOP-8	FP008-A-P-SD	FP008-A-C-SD	FP008-A-R-SD	FP008-A-L-SD

3. Product name list

3.1 S-82D9A Series

Table 2 (1 / 2)

Product Name	Detection	Detection	Detection	Detection
	Voltage 1	Voltage 2	Voltage 3	Voltage 4
	[VDET1(S)]	[Vdet2(s)]	[Vdet3(s)]	[Vdet4(s)]
S-82D9AAA-S8T1U	21.5 V	16.8 V	12.1 V	7.5 V

Table 2 (2 / 2)

	Hysteresis	Hysteresis	Hysteresis	Hysteresis	
Product Name	Width 1	Width 2	Width 3	Width 4	Output Logic*1
	[VHYS1(S)]	[VHYS2(S)]	[VHYS3(S)]	[VHYS4(S)]	
S-82D9AAA-S8T1U	500 mV	500 mV	500 mV	500 mV	Full charge all on

3.2 S-82D9B Series

Table 3 (1 / 2)

	Detection	Detection	Detection	Detection
Product Name	Voltage 1	Voltage 2	Voltage 3	Voltage 4
	[V _{DET1(S)}]	[V _{DET2(S)}]	[V _{DET3(S)}]	[V _{DET4(S)}]
S-82D9BAA-S8T1U	21.5 V	16.8 V	12.1 V	7.5 V

Table 3 (2 / 2)

	Hysteresis	Hysteresis	Hysteresis	Hysteresis	
Product Name	Width 1	Width 2	Width 3	Width 4	Output Logic*1
	[V _{HYS1(S)}]	[V _{HYS2(S)}]	[V _{HYS3(S)}]	[V _{HYS4(S)}]	
S-82D9BAA-S8T1U	500 mV	500 mV	500 mV	500 mV	Full charge all on

*1. Output Logic: Full charge all on, Individual step voltage on

Remark Please contact our sales representatives for products other than the above.

Pin Configurations

1. HTMSOP-8





Figure 3

Pin No.	Symbol	Description
1	OUT1	Voltage detection output pin 1
2	OUT2	Voltage detection output pin 2
3	OUT3	Voltage detection output pin 3
4	OUT4	Voltage detection output pin 4
5	NC*2	No connection
6	VSS	GND pin
7	EN	EN signal input pin
8	VDD	Positive power supply input pin

Table 4 S-82D9A Series

Table 5 S-82D9B Series

Pin No.	Symbol	Description
1	OUT1	Voltage detection output pin 1
2	OUT2	Voltage detection output pin 2
3	OUT3	Voltage detection output pin 3
4	OUT4	Voltage detection output pin 4
5	NC*2	No connection
6	VSS	GND pin
7	SENSE	Detection voltage input pin
8	VDD	Positive power supply input pin

- *1. Connect the heat sink of backside at shadowed area to the board and set electric potential open or V_{DD} . However, do not use it as the function of electrode.
- *2. The NC pin is electrically open. The NC pin can be connected to VDD pin or VSS pin.

■ Absolute Maximum Ratings

Table 6

		(Ta = +25°C unless other	wise specified)
Item	Symbol	Absolute Maximum Rating	Unit
Input voltage between VDD pin and VSS pin	V _{DD}	V _{SS} - 0.3 to V _{SS} + 28	V
EN pin input voltage (S-82D9A Series)	V _{EN}	V _{SS} - 0.3 to V _{SS} + 28	V
SENSE pin input voltage (S-82D9B Series)	V _{SENSE}	V _{SS} - 0.3 to V _{DD} + 0.3	V
Output voltage n	Voutn	V _{SS} - 0.3 to V _{SS} + 28	V
Operation ambient temperature	T _{opr}	-40 to +85	°C
Storage temperature	T _{stg}	-40 to +125	°C

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

Remark n = 1 to 4

■ Thermal Resistance Value

Item	Symbol	Condition		Min.	Тур.	Max.	Unit
Junction-to-ambient thermal resistance*1		HTMSOP-8	Board A	-	159	-	°C/W
			Board B	-	113	-	°C/W
	Αιθ		Board C	-	39	-	°C/W
			Board D	-	40	-	°C/W
			Board E	-	30	-	°C/W

Table 7

*1. Test environment: compliance with JEDEC STANDARD JESD51-2A

Remark Refer to "**Power Dissipation**" and "Test Board" for details.

BATTERY MONITORING IC S-82D9 Series

Electrical Characteristics

Table 8

			(T	a = +25°C	unless oth	erwise sp	pecified)
ltem	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Common							
Detection voltage n*1	VDETn	-	V _{DETn(S)} × 0.99	VDETn(S)	V _{DETn(S)} × 1.01	V	1
Hysteresis width n*2	.,	$300 \text{ mV} \le V_{\text{HYSn}(S)} \le 500 \text{ mV}$	V _{HYSn(S)} × 0.8	V _{HYSn(S)}	V _{HYSn(S)} × 1.2	V	1
	VHYSn	$0 \text{ V} \leq V_{\text{HYSn}(S)} \leq 50 \text{ mV}$	V _{HYSn(S)} - 0.025	V _{HYSn(S)}	V _{HYSn(S)} + 0.025	V	1
Operation voltage range between VDD pin and VSS pin	V _{DD}	Fixed output pin voltage	3.6	-	24	V	-
Current consumption during operation* ³	IDD1	V1 = 23 V, V2 = 23 V	-	-	10	μA	1
Current consumption during power-off	I _{DD2}	V1 = 23 V, V2 = 0 V	-	-	0.1	μA	1
<u> </u>	I _{OUTn}	Full charge all on, V1 = 23 V, V2 = 23 V, V3 = 1 V	10	-	-	mA	2
Output sink current n		Individual step voltage on V1 = V2 = $V_{DETn} + V_{HYSn}$, V3 = 1 V	10	-	-	mA	2
Output leak current n	I _{LEAKn}	V1 = 23 V, V2 = 0 V, V3 = 23 V	-	-	0.1	μA	2
S-82D9A Series							
EN pin input voltage "H"	VsH	V1 = 23 V	1.5	-	-	V	1
EN pin input voltage "H"	V _{SL}	V1 = 23 V	-	-	0.3	V	1
S-82D9B Series							
SENSE pin current	I _{SENSE}	V1 = 23 V, V2 = 23 V	-	-	10	μA	1
SENSE pin input voltage "H"	V _{SH}	V1 = 23 V	7	-	-	V	1
SENSE pin input voltage "L"	V _{SL}	V1 = 23 V	-	-	0.3	V	1

*1. V_{DETn} : Actual detection voltage value, $V_{DETn(S)}$: Set detection voltage

*2. V_{HYSn} : Actual hysteresis width, $V_{HYSn(S)}$: Set hysteresis width The relationship between V_{DETn} and V_{HYSn} is as follows. $V_{DETn} < V_{DETn} + V_{HYSn}$

*3. Current consumption = I_{VDD} + I_{EN} (S-82D9A Series) Current consumption = I_{VDD} + I_{SENSE} (S-82D9B Series)

Remark n = 1 to 4

Test Circuits







Figure 5 Test Circuit 2

Standard Circuit

1. S-82D9A Series





2. S-82D9B Series





Table 9	Constants	for	External	Com	ponents
---------	-----------	-----	----------	-----	---------

Symbol	Purpose	Тур.	Remark
R1, R2*1	For power fluctuation	470 Ω	Set the value as small as possible to prevent deterioration of the detection voltage.
C1, C2	For power fluctuation	0.1 µF	-
R _{OUTn} * ²	For output pin pull-up	1 kΩ	Make sure the power dissipation of this IC is not exceeded.

*1. Set up R1, R2 as 100 k Ω or less to prevent oscillation.

*2. Set up each of R_{OUTn} as 620 Ω or more so that the power dissipation is not exceeded.

Caution 1. The constants may be changed without notice.

2. It has not been confirmed whether the operation is normal or not in circuits other than the connection example. In addition, the connection example and the constants do not guarantee proper operation. Perform thorough evaluation using the actual application to set the constants.

Remark n = 1 to 4

Operation

1. Basic operation

1.1 S-82D9A Series

1. 1. 1 When the power supply voltage (V_{DD}) decreases

The OUTn pin becomes detection status if V_{DD} is equal to or lower than the detection voltage (V_{DETn}).

1.1.2 When the power supply voltage increases

The OUTn pin becomes release status if V_{DD} is equal to or higher than the release voltage (V_{DETn} + V_{HYSn}).

1. 1. 3 When $V_{DD} \leq$ minimum operation voltage

The OUTn pin voltage is indefinite.

1.2 S-82D9B Series

1. 2. 1 When the SENSE pin voltage (VSENSE) decreases

The OUTn pin becomes detection status if V_{SENSE} is equal to or lower than the detection voltage (V_{DETn}).

1. 2. 2 When the SENSE pin voltage increases

The OUTn pin becomes release status if V_{SENSE} is equal to or higher than the release voltage (V_{DETn} + V_{HYSn}).

1. 2. 3 When V_{SENSE} ≤ minimum operation voltage

Even if V_{SENSE} further decreases to the IC's minimum operation voltage or lower, the output from the OUTn pin is stable when V_{DD} is minimum operation voltage or higher.

2. EN pin (S-82D9A Series)

This pin starts and stops this IC.

When $V_{EN} \leq V_{SL}$ is set, all internal circuits stop operating, and Nch transistor n (refer to **Figure 1** in **"Block Diagram**") is turned off, reducing current consumption significantly.

When not using the EN pin, connect it to the VDD pin.

Refer to the circuit diagram in **Figure 11** for the circuit connection example.

3. SENSE pin (S-82D9B Series)

This pin starts and stops this IC and monitors the battery voltage.

When $V_{SENSE} \le V_{SL}$ is set, all internal circuits stop operating, and Nch transistor n (refer to **Figure 2** in **Block Diagram**") is turned off, reducing current consumption significantly.

Refer to the circuit diagram in Figure 12 and Figure 13 for the circuit connection example.

Remark n = 1 to 4

■ Timing Charts

1. S-82D9A Series (Full charge all on, $V_{EN} \ge V_{SH}$)



Figure 8

Remark When V_{DD} is equal to or lower than the minimum operation voltage, the output voltage from the OUT1 pin to the OUT4 pin is indefinite in the shaded area.

2. S-82D9A Series (Individual step voltage on, $V_{EN} \ge V_{SH}$)



Figure 9

Remark When V_{DD} is equal to or lower than the minimum operation voltage, the output voltage from the OUT1 pin to the OUT4 pin is indefinite in the shaded area.

ABLIC Inc.

3. S-82D9B Series (Full charge all on, V_{SENSE} ≥ V_{SH})



Figure 10

Remark Even if V_{SENSE} is below the minimum operating voltage of the IC, the output voltage from the OUT1 pin to OUT4 pin are stable when V_{DD} is minimum operation voltage or higher.

Application Circuits

- 1. LED battery level Indicator
 - 1.1 S-82D9A Series





Caution It has not been confirmed whether the operation is normal or not in circuits other than the connection example. In addition, the connection example and the constants do not guarantee proper operation. Perform thorough evaluation using the actual application to set the constants.



1.2 S-82D9B Series

Figure 12

Caution It has not been confirmed whether the operation is normal or not in circuits other than the connection example. In addition, the connection example and the constants do not guarantee proper operation. Perform thorough evaluation using the actual application to set the constants.

2. Change of detection voltage using S-82D9B Series

This IC can monitor battery voltage equal to or higher than the rated voltage of the IC by making the connection shown in **Figure 13**.



Figure 13

Caution It has not been confirmed whether the operation is normal or not in circuits other than the connection example. In addition, the connection example and the constants do not guarantee proper operation. Perform thorough evaluation using the actual application to set the constants.

Precautions

- The application conditions for the input voltage, output voltage, and output pin pull-up resistance should not exceed the package power dissipation.
- Wiring patterns for the VDD pin, the VOUTn pin and the VSS pin should be designed so that the impedance is low.
- Note that the detection voltage may deviate due to the resistance component of output sink current and the VSS pin wiring.
- In applications where a resistor is connected to the input (refer to Figure 11 in "■ Application Circuit"), the feed-through current which is generated when the output switches causes a voltage drop equal to feed-through current × input resistance. After the output switches, the feed-through current stops and its resultant voltage drop disappears, and the output switches. The feed-through current is then generated again, a voltage drop appears. Note that an oscillation may be generated for this reason.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
- ABLIC Inc. claims no responsibility for any disputes arising out of or in connection with any infringement by products including this IC of patents owned by a third party.

Remark n = 1 to 4

Characteristics (Typical Data)

1. Detection voltage

1.1 VDETn vs. Ta



2. Hysteresis width

2.1 V_{HYSn} vs. Ta











V_{DD} = 23 V

3. Current consumption

3.1 IDD1 VS. VDD

Rev.1.1_00



S-82D9AAA







4. Output current





Remark n = 1 to 4

 $\begin{array}{c} 6.0 \\ 4.0 \\ 2.0 \\ 0.0 \\ -40 \\ -40 \\ -25 \\ -40 \\ -25 \\ 75 \\ 85 \\ 75 \\ 85 \end{array}$





5.1 tDETn VS. VOV_DET



Figure 14 Test Condition of Response Time

Remark 1. Refer to "Figure 4 Test Circuit 1" for the test condition of the response time.
2. n = 1 to 4

Marking Specifications

1. HTMSOP-8



Blank (2) to (4): Product code (Refer to Product name vs. Product code) Blank (6) to (8): Lot number

Product name vs. Product code

1.1 S-82D9A Series

Braduat Nama	Product Code		
Product Marine	(2)	(3)	(4)
S-82D9AAA-S8T1U	9	Y	А

(1):

(5):

1.2 S-82D9B Series

Draduat Nama	Product Code		
Product Name	(2)	(3)	(4)
S-82D9BAA-S8T1U	9	Y	С

Power Dissipation

HTMSOP-8



Board	Power Dissipation (P _D)
А	0.63 W
В	0.88 W
С	2.56 W
D	2.50 W
E	3.33 W

HTMSOP-8 Test Board

) IC Mount Area

(1) Board A



Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		2
Copper foil layer [mm]	1	Land pattern and wiring for testing: t0.070
	2	-
	3	-
	4	74.2 x 74.2 x t0.070
Thermal via		-

(2) Board B



Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		4
Copper foil layer [mm]	1	Land pattern and wiring for testing: t0.070
	2	74.2 x 74.2 x t0.035
	3	74.2 x 74.2 x t0.035
	4	74.2 x 74.2 x t0.070
Thermal via		-

(3) Board C



Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		4
	1	Land pattern and wiring for testing: t0.070
Coppor foil lover [mm]	2	74.2 x 74.2 x t0.035
Copper foir layer [mm]	3	74.2 x 74.2 x t0.035
	4	74.2 x 74.2 x t0.070
Thermal via		Number: 4 Diameter: 0.3 mm

≣∎≣

enlarged view

No. HTMSOP8-A-Board-SD-1.0

HTMSOP-8 Test Board

Item

Size [mm]

🔵 IC Mount Area

Specification

(4) Board D





114.3 x 76.2 x t1.6



enlarged view

(5) Board E



Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		4
Copper foil layer [mm]	1	Pattern for heat radiation: 2000mm ² t0.070
	2	74.2 x 74.2 x t0.035
	3	74.2 x 74.2 x t0.035
	4	74.2 x 74.2 x t0.070
Thermal via		Number: 4 Diameter: 0.3 mm



enlarged view

No. HTMSOP8-A-Board-SD-1.0



ABLIC Inc.







Disclaimers (Handling Precautions)

- 1. All the information described herein (product data, specifications, figures, tables, programs, algorithms and application circuit examples, etc.) is current as of publishing date of this document and is subject to change without notice.
- The circuit examples and the usages described herein are for reference only, and do not guarantee the success of any specific mass-production design.
 ABLIC Inc. is not liable for any losses, damages, claims or demands caused by the reasons other than the products described herein (hereinafter "the products") or infringement of third-party intellectual property right and any other right due to the use of the information described herein.
- 3. ABLIC Inc. is not liable for any losses, damages, claims or demands caused by the incorrect information described herein.
- 4. Be careful to use the products within their ranges described herein. Pay special attention for use to the absolute maximum ratings, operation voltage range and electrical characteristics, etc. ABLIC Inc. is not liable for any losses, damages, claims or demands caused by failures and / or accidents, etc. due to the use of the products outside their specified ranges.
- 5. Before using the products, confirm their applications, and the laws and regulations of the region or country where they are used and verify suitability, safety and other factors for the intended use.
- 6. When exporting the products, comply with the Foreign Exchange and Foreign Trade Act and all other export-related laws, and follow the required procedures.
- 7. The products are strictly prohibited from using, providing or exporting for the purposes of the development of weapons of mass destruction or military use. ABLIC Inc. is not liable for any losses, damages, claims or demands caused by any provision or export to the person or entity who intends to develop, manufacture, use or store nuclear, biological or chemical weapons or missiles, or use any other military purposes.
- 8. The products are not designed to be used as part of any device or equipment that may affect the human body, human life, or assets (such as medical equipment, disaster prevention systems, security systems, combustion control systems, infrastructure control systems, vehicle equipment, traffic systems, in-vehicle equipment, aviation equipment, aerospace equipment, and nuclear-related equipment), excluding when specified for in-vehicle use or other uses by ABLIC, Inc. Do not apply the products to the above listed devices and equipments. ABLIC Inc. is not liable for any losses, damages, claims or demands caused by unauthorized or unspecified use of the products.
- 9. In general, semiconductor products may fail or malfunction with some probability. The user of the products should therefore take responsibility to give thorough consideration to safety design including redundancy, fire spread prevention measures, and malfunction prevention to prevent accidents causing injury or death, fires and social damage, etc. that may ensue from the products' failure or malfunction.

The entire system in which the products are used must be sufficiently evaluated and judged whether the products are allowed to apply for the system on customer's own responsibility.

- 10. The products are not designed to be radiation-proof. The necessary radiation measures should be taken in the product design by the customer depending on the intended use.
- 11. The products do not affect human health under normal use. However, they contain chemical substances and heavy metals and should therefore not be put in the mouth. The fracture surfaces of wafers and chips may be sharp. Be careful when handling these with the bare hands to prevent injuries, etc.
- 12. When disposing of the products, comply with the laws and ordinances of the country or region where they are used.
- 13. The information described herein contains copyright information and know-how of ABLIC Inc. The information described herein does not convey any license under any intellectual property rights or any other rights belonging to ABLIC Inc. or a third party. Reproduction or copying of the information from this document or any part of this document described herein for the purpose of disclosing it to a third-party is strictly prohibited without the express permission of ABLIC Inc.
- 14. For more details on the information described herein or any other questions, please contact ABLIC Inc.'s sales representative.
- 15. This Disclaimers have been delivered in a text using the Japanese language, which text, despite any translations into the English language and the Chinese language, shall be controlling.



2.4-2019.07